



深圳市奥伦德科技股份有限公司  
Shenzhen Orient Technology Co.,Ltd

# 产品规格书

# Specification Sheet

品 名(P/N): 光电耦合器 Photocoupler

客户名称(Customer): \_\_\_\_\_

本厂型号(Mfg P/N): OR-306X

日 期(Date): \_\_\_\_\_



## ● 特点 (Features)

- 绝缘电压: (Isolation voltage between input and output)  $V_{iso} \geq 5,000\text{Vrms}$
- 6脚零交叉可控硅光电隔离器 (6pin DIP zero-cross optoisolators triac driver output)
- 符合欧盟 REACH 标准 (Compliance with EU REACH)
- 产品符合 RoHS 要求 (The product itself will remain within RoHS compliant version)
- 运行温度范围: (Operating temperature) -40 °C to +110 °C

## ● 说明 (description)

描述该系列器件包含一个红外发光二极管和光电探测器。不含卤素和 Sb<sub>2</sub>O<sub>3</sub>.

## ● 应用范围 (Application Range)

- |                             |                                  |
|-----------------------------|----------------------------------|
| •交流电动机驱动 (AC Motor Drives)  | •交流电机启动器 (AC Motor Starters)     |
| •照明控制 (Lighting Controls)   | •电磁阀控制 (Solenoid/Valve Controls) |
| •固态继电器 (Solid State Relays) | •温度控制器 (Temperature Controls)    |

## ● 最大绝对额定值(常温 T=25°C) Max Absolute rated Value (Normal Temperature=25°C)

参数 Parameter		符号 Symbol	典型值 Rated Value	单位 Unit
输入 Input	正向电流 (Forward Current)	I <sub>F</sub>	50	mA
	结温 (Junction Temperature)	T <sub>J</sub>	125	°C
	逆向电压 (Reverse Voltage)	V <sub>R</sub>	6	V
	功率耗损 (Power Dissipation)	P	100	mW
输出 Output	断态重复峰值电压 (Off-State Output Terminal Voltage)	V <sub>DRM</sub>	600	V
	峰值重复浪涌电流 Peak Repetitive Surge Current (PW=1ms, 120 pps)	I <sub>TSM</sub>	1	A
	结温 (Junction Temperature)	T <sub>J</sub>	125	°C
	集电极功率耗损 (Collector Power Dissipation)	P <sub>C</sub>	150	mW
总功率消耗 (Total Power Dissipation)		P <sub>tot</sub>	250	mW
*1 绝缘电压 (Insulation Voltage)		V <sub>iso</sub>	5000	Vrms
工作温度 (Working Temperature)		Topr	-40 ~ + 110	°C
存贮温度 (Deposit Temperature)		T <sub>stg</sub>	-55 ~ + 110	
*2 焊锡温度 (Soldering Temperature)		T <sub>sol</sub>	260	

\*1. 交流测试, 时间 1 分钟, R.H.=40~60% AC Test, 1 minute, humidity = 40~60%  
如下是绝缘测试的方法. Insulation test method as below:

- (1) 将产品的两端短路。 Short circuit both terminals of photocoupler
- (2) 测试绝缘电压时无电流通过。 No Current when testing insulation voltage
- (3) 测试时加正弦波形电压。 Adding sine wave voltage when testing

\*2. 锡焊时间为 10 秒 soldering time is 10 seconds



● 光电特性(常温 T=25℃) (Opto-electronic Characteristics)

参数 Parameter		符号 Symbol	条件 Condition	最小 Min	典型值 Typ.*	最大 Max	单位 Unit
输入 (Input)	正向电压 (Forward Voltage)	V <sub>F</sub>	I <sub>F</sub> =20mA	---	1.2	1.6	V
	逆向电流(Reverse Current)	I <sub>R</sub>	V <sub>R</sub> =6V	---	0.05	10	μA
输出 (Output)	1.峰值阻断电流, 任一方向 (Peak Blocking Current, Either Direction)	I <sub>DRM</sub>	V <sub>DRM</sub> = 600V	---	---	500	nA
	峰值状态电压, 任一方向 ( Peak On-State Voltage, Either Direction)	V <sub>TM</sub>	I <sub>TM</sub> =100mA Peak	---	---	3.0	V
	2.断态电压临界上升率 (Critical rate of Rise of Off-State Voltage)	dv/dt	V <sub>in</sub> =240Vrms	1000	---	---	V/us
组合 Couple	3.LED 触发电流, 锁存输出所需的电流, 任一方向 (Led Trigger Current, Current Required to Latch Output, Either Direction)	3061	I <sub>FT</sub>	Main Terminal Voltage = 3V	---	---	15
		3062			---	---	10
		3063			---	---	5
	Holding Current, Either Direction	I <sub>H</sub>			400	---	uA
ZERO CROSSING	抑制电压 (Inhibit Voltage)	V <sub>INH</sub>	I <sub>F</sub> = Rated I <sub>FT</sub> , MT1-MT2 Voltage above which device will not trigger.	---	5	20	Volts
	泄漏处于抑制状态 (Leakage in Inhibited State )	I <sub>DRM2</sub>	I <sub>F</sub> = Rated I <sub>FT</sub> , Rated V <sub>DRM</sub> , Off State	---	---	500	μA

\*1. Test voltage must be applied within dv/dt rating.

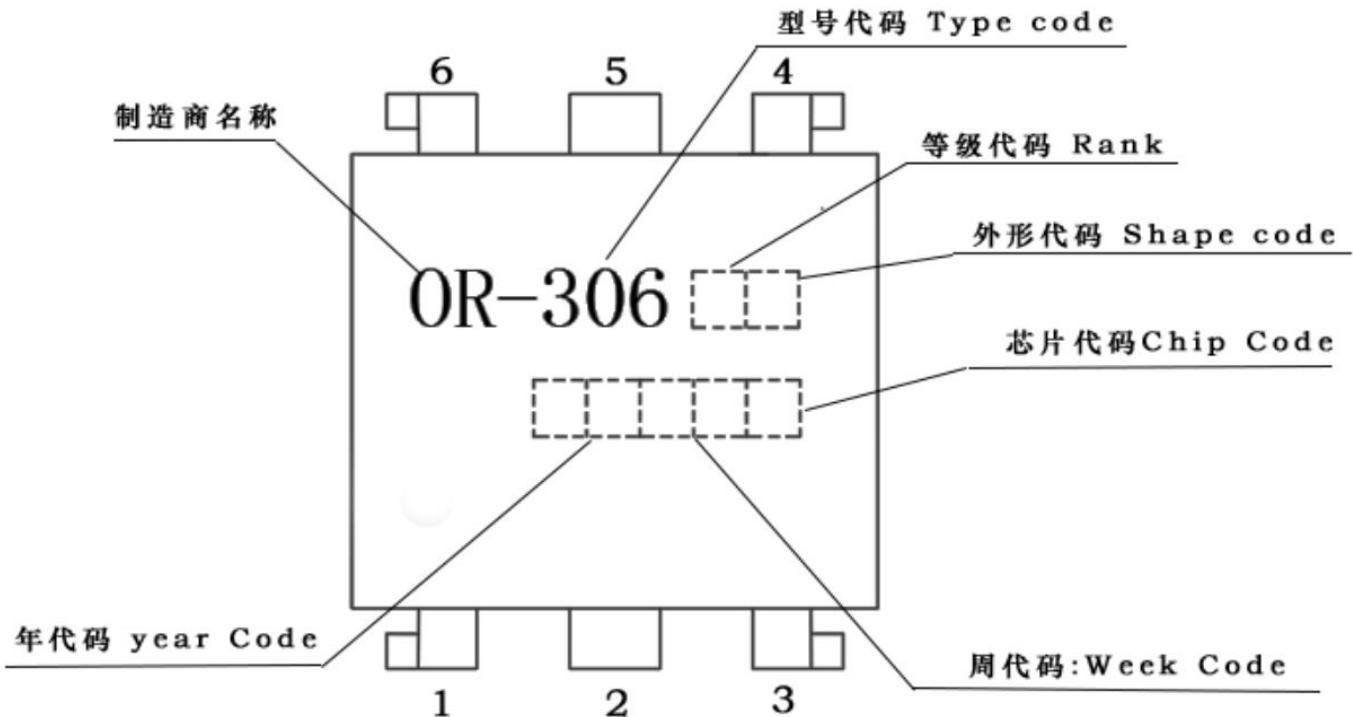
\*2. This is static dv/dt. Commutating dv/dt is a function of the load-driving thyristor(s) only.

\*3. All devices are guaranteed to trigger at an I<sub>F</sub> value less than or equal to max I<sub>FT</sub>.

Therefore, recommended operating I<sub>F</sub> lies between max I<sub>FT</sub>, 15 mA for 3061, 10 mA for 3062, 5 mA for 3063, and absolute max I<sub>F</sub> (50mA).



## ● 命名规则(Naming Rule)



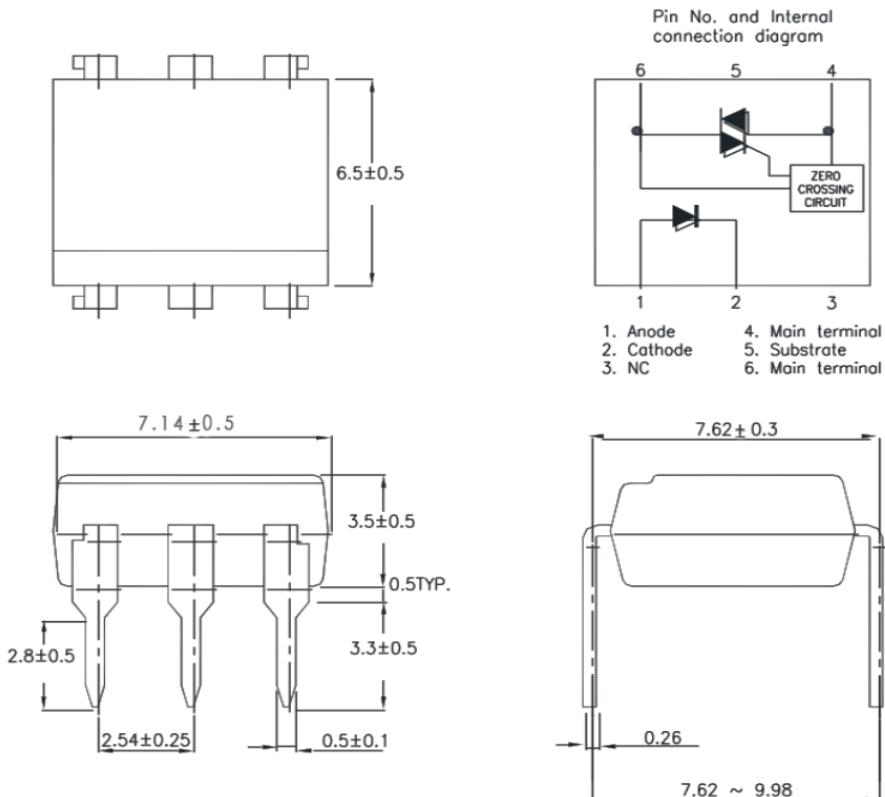
### 注:

- 1、制造商名称: OR代表制造商 Shenzhen Orient Components Co., Ltd.
- 2、型号代码 Type Code: 306 代表光耦产品型号
- 3、等级代码 Rank: 有1、2、3共3种形式，X=1代表3061；X=2代表3062；X=3代表3063。
- 4、外形代码Shape code: 空白--代表外形OR-306X；M--代表OR-306XM；S--代表OR-306XS,具体请看外形尺寸。
- 5、年代码:Year Code:   例如: F8 或C8, 其中F表铁支架/C表铜支架, 8代表2018年、依此类推.
- 6、周代码:Week Code:   01代表第一周、02代表第二周、依此类推
- 7、单位: mm

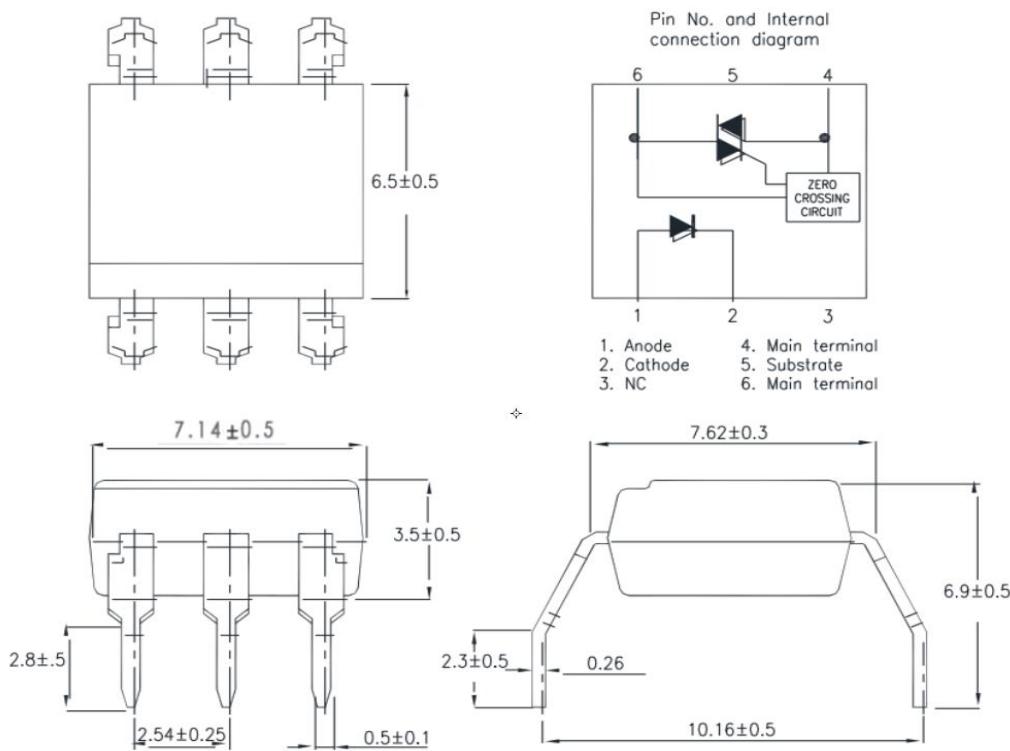


## ● 外形尺寸 (Outer Dimension)

### 1. OR-306X

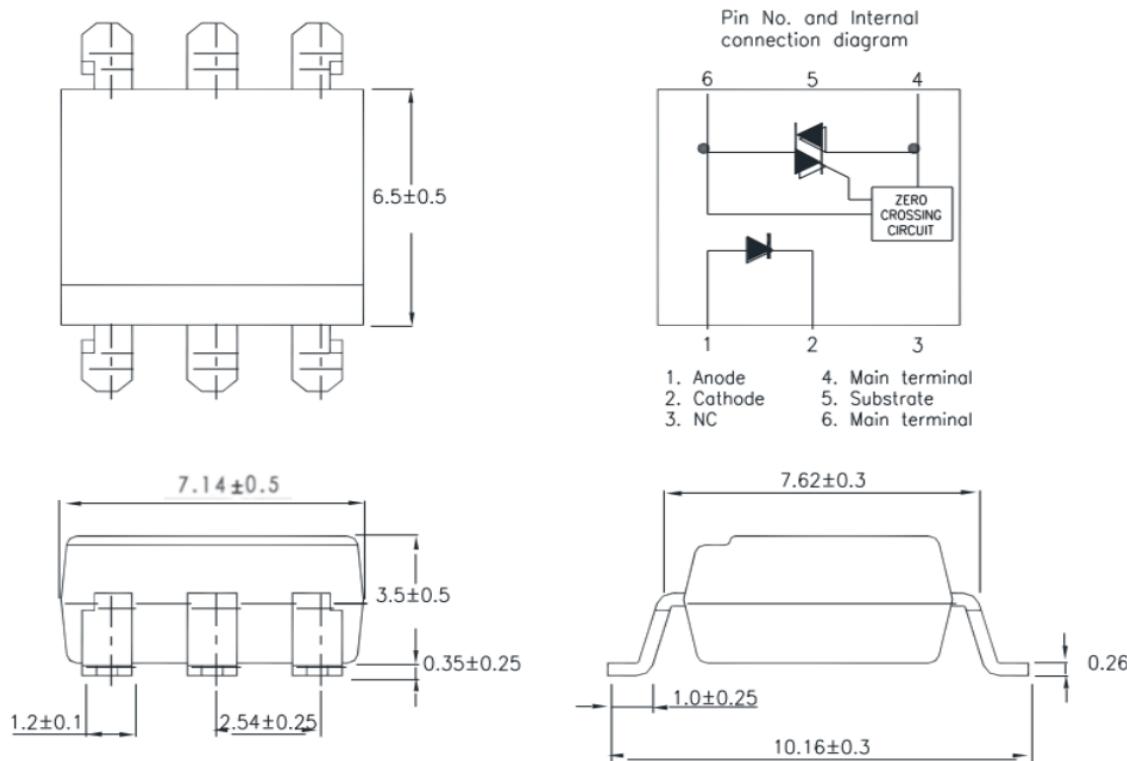


### 2. OR-306XM



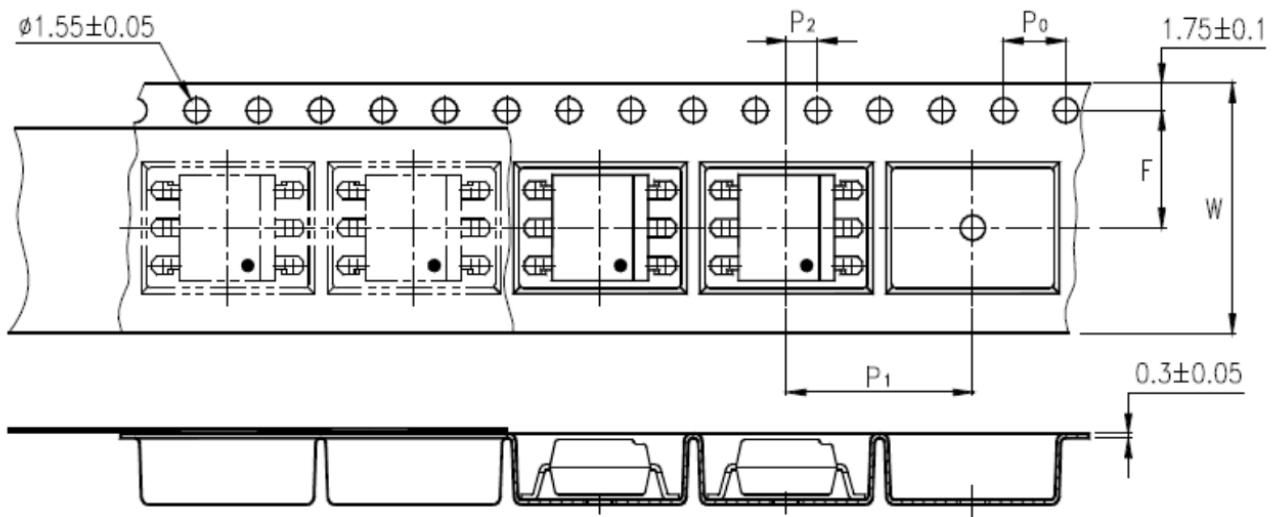


### 3. OR-306XS



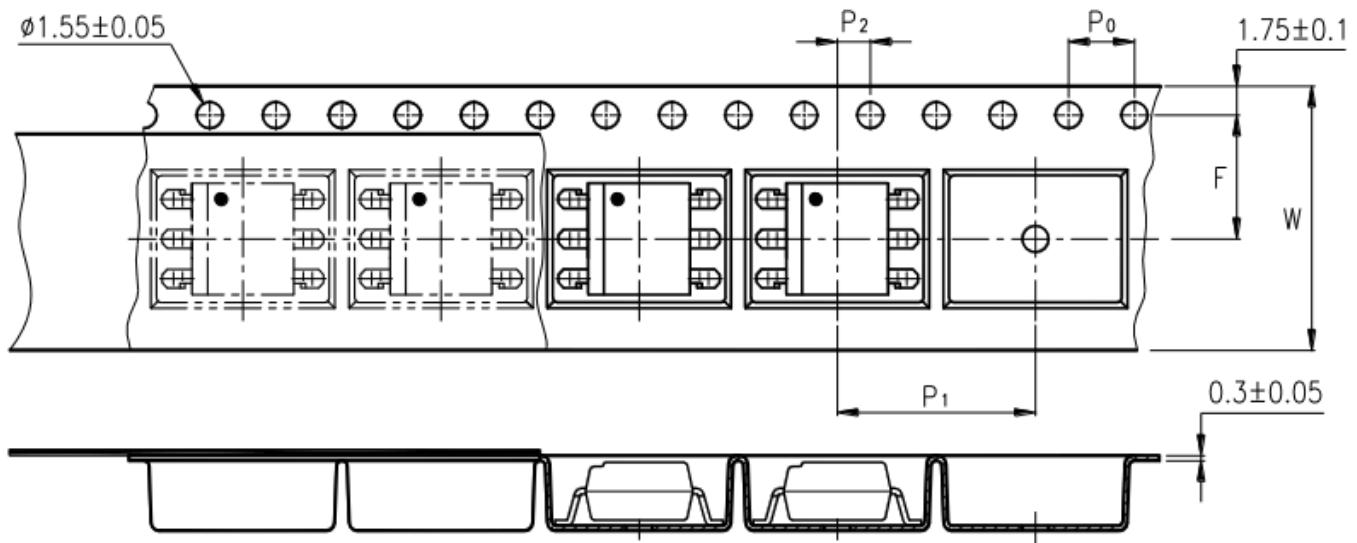
### ● 编带尺寸 (Taping Dimensions)

#### 1. OR-306XS-TA





## 2. OR-306XS-TA1



Description	Symbol	Dimension in mm (inch)
Tape wide	W	16±0.3 (0.63)
Pitch of sprocket holes	P0	4±0.1 (0.15)
Distance of compartment	F	7.5±0.1 (0.295)
	P2	2±0.1 (0.079)
Distance of compartment to compartment	P1	12±0.1 (0.472)

封装类型	306XS series(TA/TA1)
数量(个)	1000

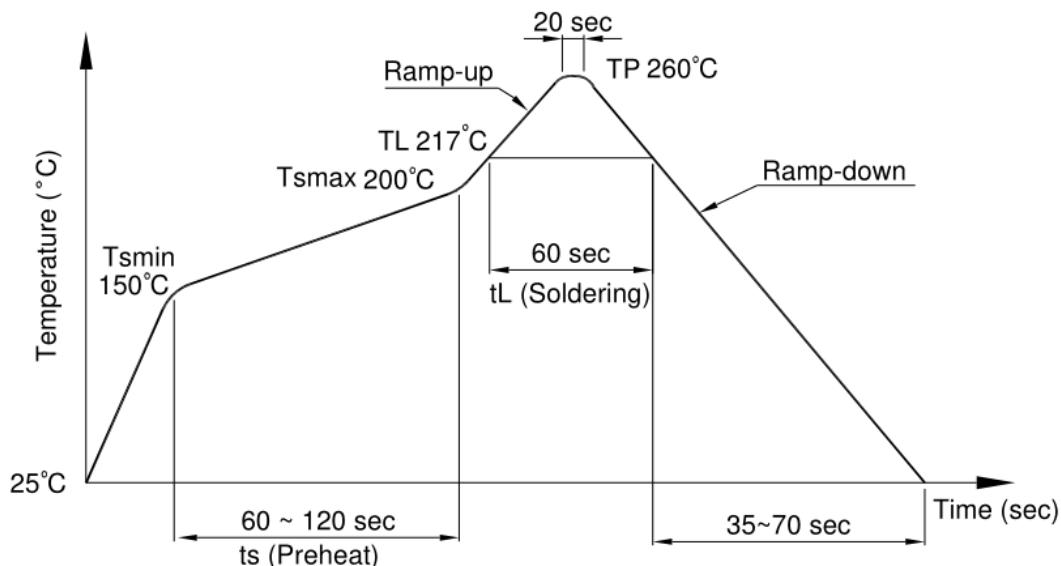


## ● 焊接温度曲线 (Temperature Profile Of Soldering)

### 1. 红外回流焊 (jedec-std-020c 兼容) (IR Reflow soldering (JEDEC-STD-020C compliant))

注意：一次焊接回流建议在温度和时间配置文件如下所示的条件下。不要焊接超过三次。

配置项	条件
预热 (Preheat) -最低温度 (TSmin )	150°C
-最高温度 (TSmax )	200°C
-时间 (最小到最大 (TS))	90±30 sec
焊接区 (Soldering zone) -温度 (TL)	217°C
-时间 (tL)	60 sec
峰值温度 (Peak Temperature)	260°C
爬升率 (Ramp-up rate)	3°C / sec max.
下降率 (3°C / sec max.)	3~6°C / sec

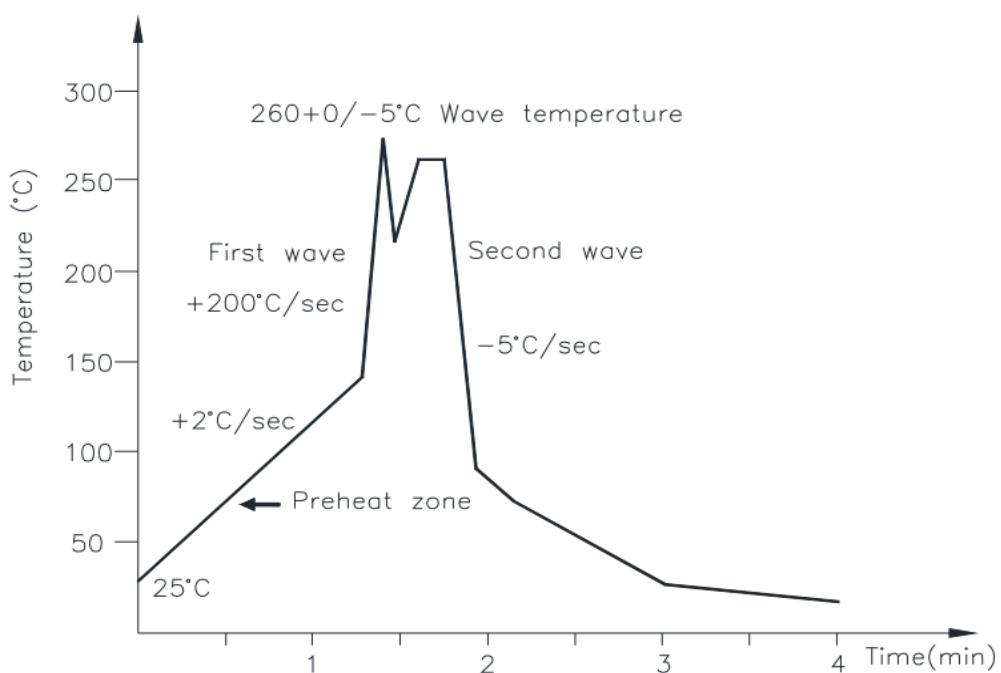




## 2. 波峰焊接 (jedec22a111 兼容) (Wave soldering (JEDEC22A111 compliant))

建议在温度条件下一次性焊接。

温度 (Temperature)	260+0/-5°C
时间 (Time)	10 sec
预热温度 (Preheat temperature)	5 to 140°C
预热时间 (Preheat time)	30 to 80 sec



## 3. 电烙铁手工焊接 (Hand soldering by soldering iron)

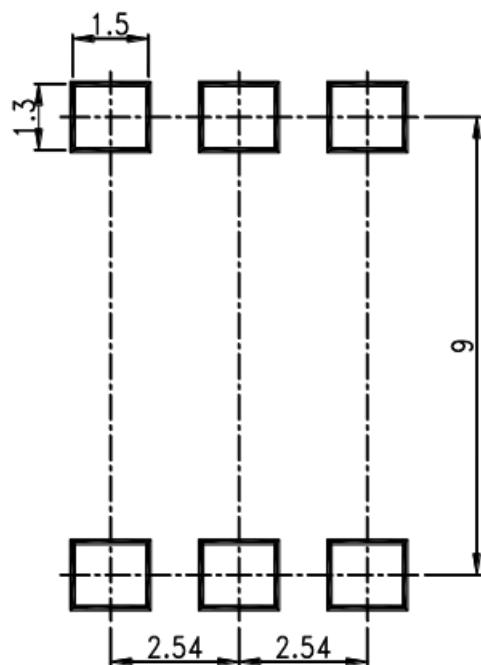
允许单铅焊接在每一个过程中, 建议一次性焊接。

温度 (Temperature)	380+0/-5°C
时间 (Time)	3 sec max



● 推荐的焊盘 (Temperature Profile Of Soldering)

Unit: mm



- 特性曲线 Characteristics Curve

Fig.1 Forward Current vs.  
Ambient Temperature

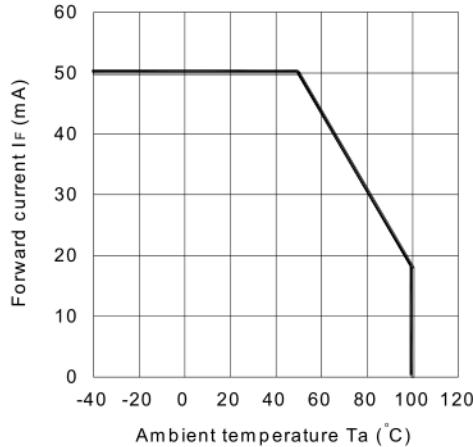


Fig.2 On-state Current vs. Ambient  
Temperature

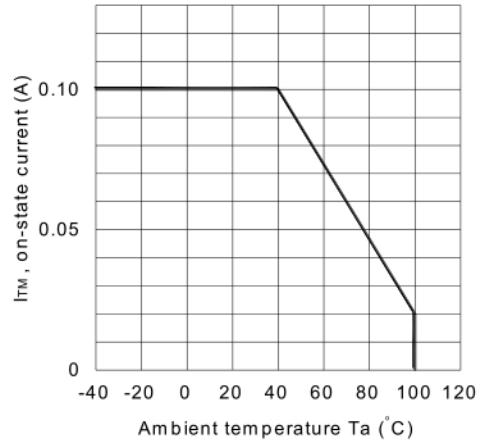


Fig.3 Minimum Trigger Current  
vs. Ambient Temperature

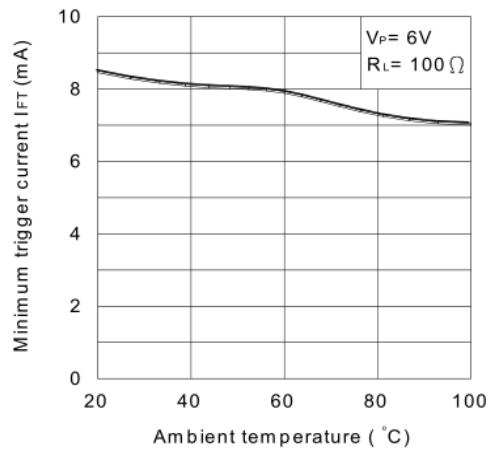


Fig.4 Forward Current vs. Forward  
Voltage

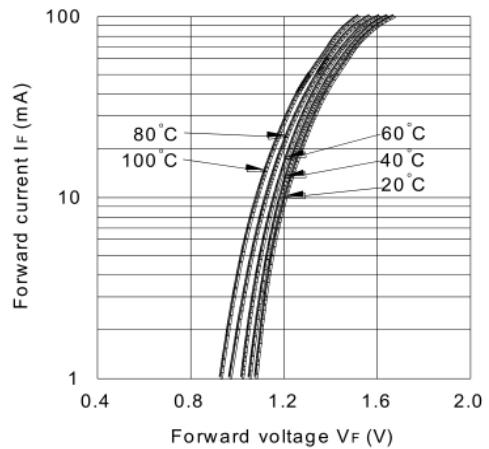


Fig.5 On-state Voltage vs. Ambient  
Temperature

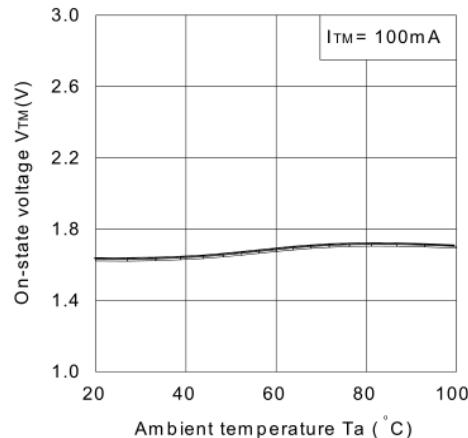


Fig.6 Holding Current vs.  
Ambient Temperature

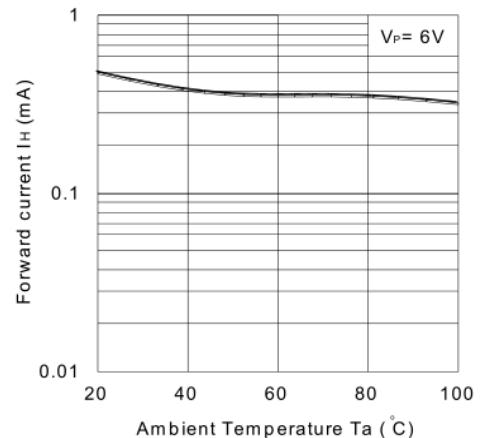


Fig.7 Repetitive Peak Off-state Current vs. Temperature

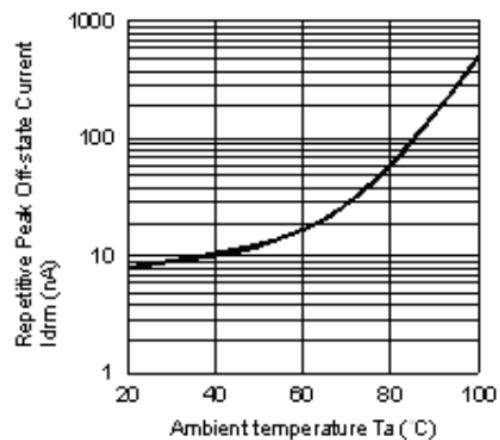
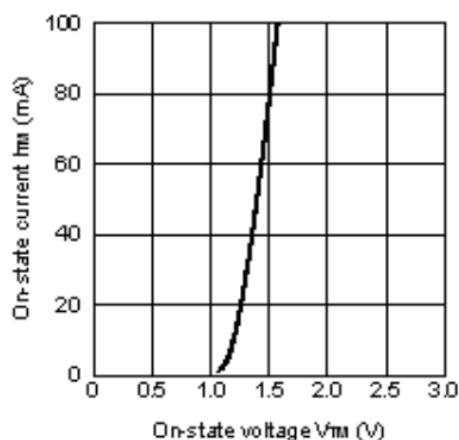
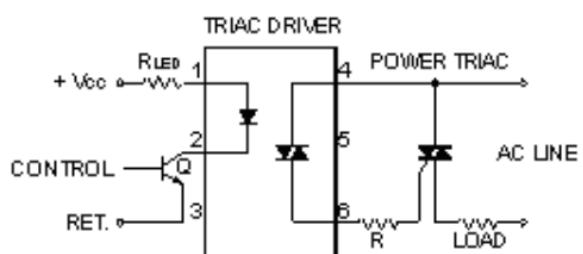


Fig.8 On-state Current vs. On-state Voltage



Basic Driver Circuit



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